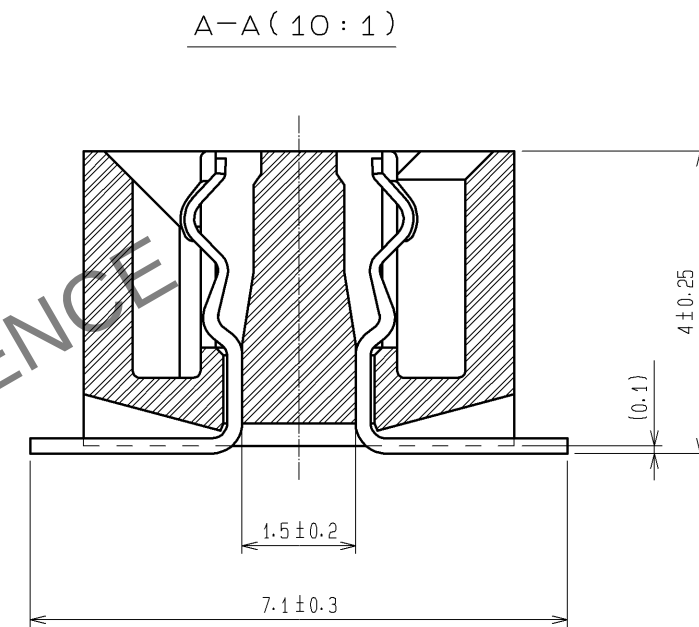
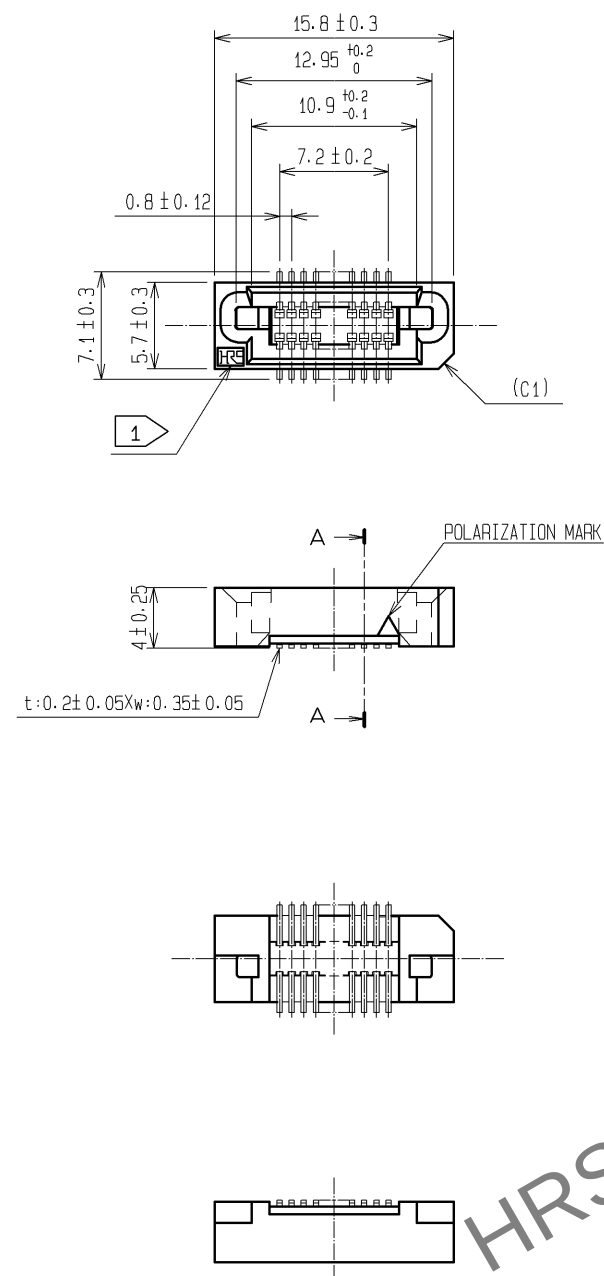
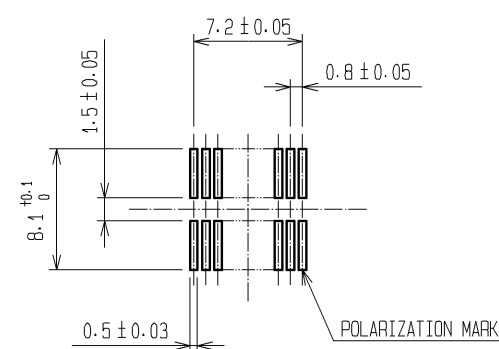




RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE)
(METAL MASK THICKNESS:t=0.15)



NOTE

1	HS MARK SHALL BE OPTIONAL.
2	LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
3	FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES.
4	THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

1	PPS	LIGHT BROWN (UL94V-0)	2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1μm min.				
					LEAD AREA:TIN-PLATING 1μm min.				
					UNDER PLATING:NICKEL 2μm min.				
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED	: HS. OKAWA	08. 06. 23	DRAWING NO. EDC3-071317-25				
		CHECED	: HT. YAMAGUCHI	08. 06. 20	PART NO. FX6A-20S-0. 8SV(71)				
		DESIGNED	: KN. SHIBUYA	08. 06. 20	CODE NO. CL576-0301-7-71				
		DRAWN	: TH. SANO	08. 06. 19					
						 1/1			